TOSHIBA PHOTOCOUPLER GaAs IRED & PHOTO-TRIAC

TLP3041(S),TLP3042(S),TLP3043(S)

OFFICE MACHINE HOUSEHOLD USE EQUIPMENT TRIAC DRIVER SOLID STATE RELAY

The TOSHIBA TLP3041 (S), TLP3042 (S), TLP3043 (S) consist of a zero voltage crossing turn-on photo-triac optically coupled to a gallium arsenide infrared emitting diode in a six lead plastic DIP package. All parameters are tested to the specification of TLP3041, TLP3042, TLP3043.

- Peak Off-State Voltage : 400 V (min)
 - Trigger LED Current : 15 mA (max) (TLP3041) 10 mA (max) (TLP3042) 5 mA (max) (TLP3043) : 100 mA (max)

: UL1577, File No. E67349

• On-State Current

•

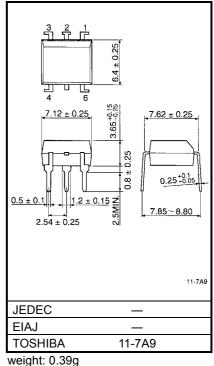
- UL Recognized
- : 5000 Vrms (min) • Isolation Voltage
- Option (D4) Type **VDE** Approved : DIN VDE0884 / 06.92 Certificate No. 68329

Maximum Operating Insulation Voltage : 890 Vpk Highest Permissible Over Voltage : 8000 Vpk

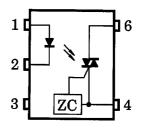
Note: When a VDE0884 approved type is needed, please designate the "Option (D4)"

Device Construction

	7.62mm pich standard type	10.16 mm pich (LF2) type
Creepage Distance	7.0 mm (min)	8.0 mm (min)
Clearance	7.0 mm (min)	8.0 mm (min)
Insulation Thickness	0.5 mm (min)	0.5 mm (min)



PIN CONFIGURATION (Top view)



- ANODE 1:
- 2: CATHODE
- 3: N.C.
- **TERMINAL 1** 4:
- **TERMINAL 2** 6:

Unit: mm

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC			SYMBOL	RATING	UNIT	
	Forward Current		١ _F	50	mA	
0	Forward Current Derati (Ta ≥ 53°C)	ng	ΔI _F / °C	-0.7	mA / °C	
	Peak Forward Current (100 µs pulse, 100 pps)		I _{FP}	1	А	
LED	Power Dissipation		PD	100	mW	
	Power Dissipation Derating (Ta ≥ 25°C)		ΔP _D / °C	-1.0	mW / °C	
	Reverse Voltage		V _R	5	V	
	Junction Temperature		Тj	125	°C	
	Off-State Output Termi	nal Voltage	V _{DRM}	400	V	
	On-Stage RMS	Ta = 25°C		100	mA	
DETECTOR	Current	Ta = 70°C	I _{T(RMS)}	50	IIIA	
	On-State Current Derating (Ta ≥ 25°C)		ΔI _T / °C	-1.1	mA / °C	
	Peak On-Stage Curren (100 µs pulse, 120 pps)	t	I _{TP}	2	А	
	Peak Nonrepetitive Sur Current (P _W = 10ms, D		I _{TSM}	1.2	А	
	Power Dissipation		PD	300	mW	
	Power Dissipation Dera (Ta ≥ 25°C)	ating	ΔP _D / °C	-4.0	mW / °C	
	Junction Temperature		Тj	115	°C	
Stora	age Temperature Range		T _{stg}	-55 ~ 150	°C	
Operating Temperature Range			T _{opr}	-40 ~ 100	°C	
Lead Soldering Temperature (10s)			T _{sol}	260	°C	
Total Package Power Dissipation			P _T	330	mW	
Total Package Power Dissipation Derating (Ta ≥ 25°C)		ΔP _T / °C	-4.4	mW / °C		
	tion Voltage 1 min., R.H. ≤ 60%)	BVS	5000	Vrms		

Note 1: Device considered a two terminal device: Pins 1, 2 and 3 shorted together and pins 4 and 6 shorted together.

RECOMMENDED OPERATING CONDISTIONS

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Supply Voltage	V _{AC}	_	_	120	Vac
Forward Current	I _F *	15	20	25	mA
Peak On-Stage Current	I _{TP}	_	_	1	А
Operating Temperature	T _{opr}	-25	_	85	°C

*: In the case of TLP3042

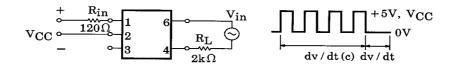
INDIVIDUAL ELECTRICAL CHARACTERISTICS (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
	Forward Voltage	V _F	I _F = 10mA	1.0	1.15	1.3	V
LED	Reverse Current	I _R	V _R = 5V			10	μA
	Capacitance	CT	V = 0, f = 1MHz	_	10	_	pF
~	Peak Off-State Current	I _{DRM}	V _{DRM} = 400V		10	100	nA
	Peak On-Stage Voltage	V _{TM}	I _{TM} = 100mA	_	1.7	3.0	V
CTO	Holding Current	Ι _Η	—	_	0.6	_	mA
DETECTOR	Critical Rate of Rise of Off- State Voltage	dv / dt	V _{in} = 120Vrms, Ta = 85°C (Fig.1)	200	500		V / μs
	Critical Rate of Rise of Commutating Voltage	dv / dt(c)	V _{in} = 30Vrms, IT = 15mA (Fig.1)		0.2		V / μs

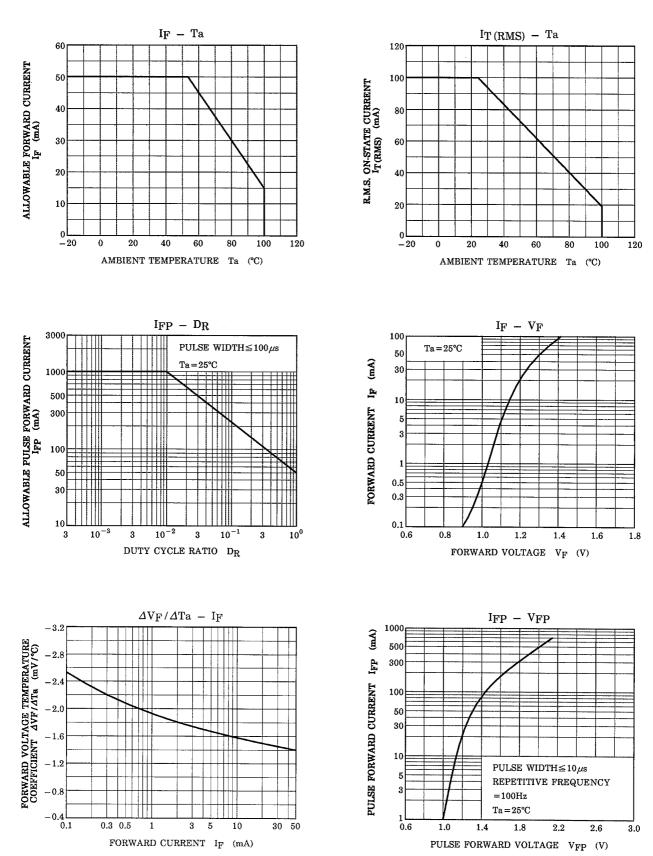
COUPLED ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
	TLP3041	IFT	V _T = 3V		_	15	mA
Trigger LED Current	TLP3042				5	10	
	TLP3043					5	
Inhibit Voltage		V _{IH}	I _F = Rated I _{FT}			40	V
Leakage in Inhibited State		Ін	I _F = Rated I _{FT} V _T = Rated V _{DRM}	_	100	300	μA
Capacitance Input to Output		CS	V _S = 0, f = 1MHz		0.8		pF
Isolation Resistance		R _S	V _S = 500V (R.H. ≤ 60%)	5×10 ¹⁰	10 ¹⁴		Ω
Isolation Voltage		BVS	AC, 1 minute	5000			Vrms
			AC, 1 second (in oil)		10000		
			DC, 1 minute (in oil)		10000		Vdc

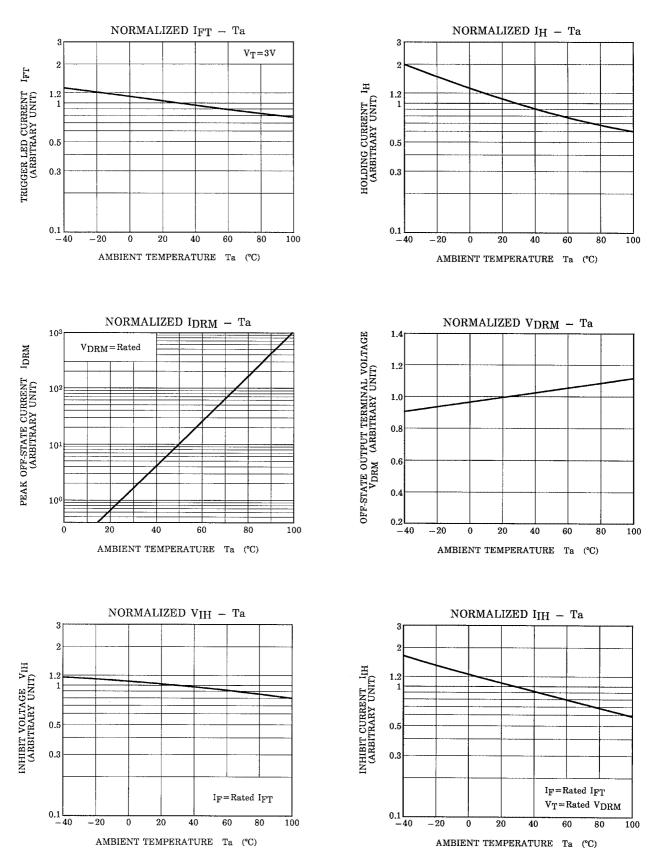
Fig. 1 dv / dt TEST CIRCUIT



TOSHIBA



TOSHIBA



RESTRICTIONS ON PRODUCT USE

000707EBC

- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
 In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic garbage.
- The products described in this document are subject to the foreign exchange and foreign trade laws.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.
- The information contained herein is subject to change without notice.

This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.